

## Accelerator Design and Integration Meeting at DESY

#### **ML-SCRF Session Summary**

May 28-29, 2009

#### Subjects discussed

- 1. Cavity Field Gradient and the Re-baseline
- 2. HLRF: RF Distribution System



#### PM "SB2009" Proposal

- A Main Linac length consistent with an optimal choice of average accelerating gradient
  - currently 31.5 MV/m, to be re-evaluated
- Single-tunnel solution for the Main Linacs and RTML,
  - with two possible variants for the HLRF
    - Klystron cluster scheme
    - DRFS scheme
- Undulator-based e+ source located at the end of the electron Main Linac (250 GeV)
- Reduced parameter set (with respect to the RDR) with  $n_b = 1312$  and a 2ms RF pulse.
- ~3.2 km circumference damping rings at 5 GeV, 6 mm bunch length.
- Single-stage bunch compressor with a compression factor of 20.
- Integration of the e+ and e- sources into a common "central region beam tunnel", together with the BDS.

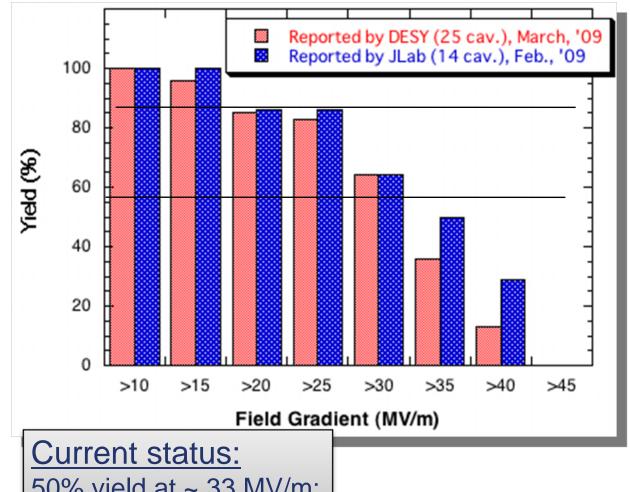
## ilc Global Plan for SCRF R&D

Calender Year	2007	07 2008 2009 201		010	2011	2012			
Technical Design Phase		TDP-1				TDP-2			
Cavity Gradient R&D to reach 35 MV/m		Process Yield Pro			oduction Yield >90%				
Cavity-string test: with 1 cryomodule				bal collab. 31.5 MV/m>					
System Test with beam 1 RF-unit (3-modulce)		FLASH	SH (DESY)			STF2 (KEK) NML (FNAL)			



#### Progress Towards High-Gradient Yield





50% yield at ~ 33 MV/m; (80% >25MV/m)

Recent DESY/JLab "production" series.

Total 39 cavities (08/09)

Mostly result of <u>first</u> <u>cold-test</u> (few cases second-test)

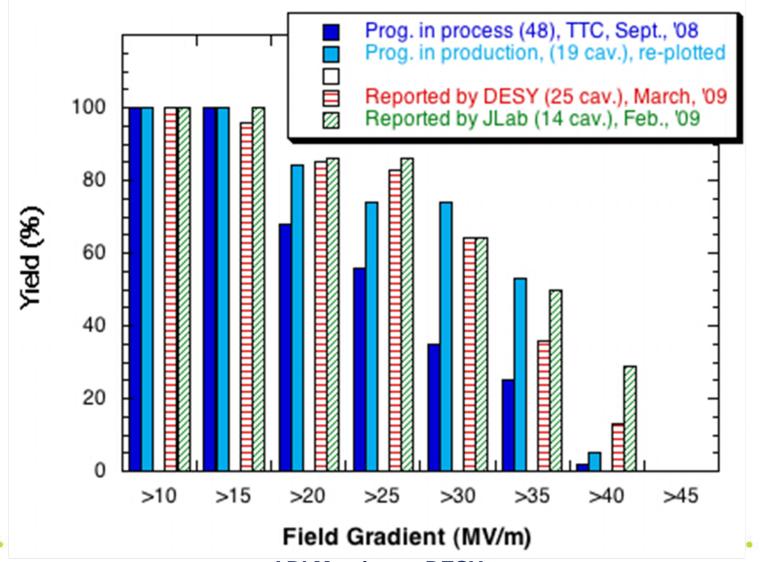
Field Emission greatly reduced (rinses)

→ identified RDR barrier

Baseline gradient reevaluation (TDP1) expected to be based on sample of >60 cavities



## Progress summarized at TTC and recently reported by DESY/Jlab ('09)





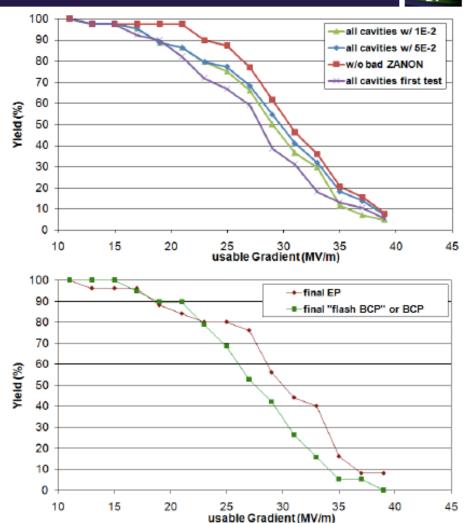


XFEL Accelerator

#### Progress Integrated at DESY



- cavity progress can be evaluated on the basis of 44 measured cavities
  - >23 cavities w/o He tank
  - 21 cavities with He tank. i.e. XFEL configuration
  - Approx. 60% of the cavities with final electro-polishing (EP)
  - Approx. 25% with additional High Pressure Rinsing (HPR) due to field emission (FE)
  - Difference between first and last test dominated by FE reduction
  - Definition of radiation limit at XFEL gradients not too critical
  - choice of final surface treatment impacts yield at higher gradients
  - yield seems to depend on steps after the final chemical treatment: further improvement expected for series production









#### What we need to make clear?

Reported by	Date of Rep.	# of cavities ordered	# of cavities accepted & meas.	# of cavities w/ EP processed	# of meas. after EP	Yield at 35 MV/m	Note/ Understandi ng
TTC H. Padamsee	08/10	?	19	19	(48)	~50% ~25 %	Process Y.
DESY: D. Reschke W. Singer, L. Lilje,	09/03	?	25	25	25 +?	~40 %	Accepted Product. Y.
Jlab R. Geng	09/02	14	14	14	14+?	~50 %	Product. Y.
DESY H. Weise	09/05	44+?	44	44x~0.6	44x0.6+?	15 %	Accepted Produc. Y.



#### For Discussions

- What is our current understanding?
  - Original S0 concept assumed:
    - Surface can be reset according to the EP process, and
    - Multiple processes may be integrated for statistics.
  - Several years of experience shows,
    - Repeat processing may cause degradation
      - Possibly because of other reasons,
  - Processing and Test recipe has changed
    - Complete the process and test only with the first cycle, and
    - Not to process more, if the result acceptable.
- How can we update the definition of yield evaluation?
  - We need to discuss it, and task force group with persons in charge
    - to monitor and accumulate the data base in an agreed evaluation approach.



#### **Further Discussions**

- Led by Rongli (Geng) with his presentations and discussions, and
- Followed by Camille (Ginsburg) with her presentation and discussions on the current status on the data base and further international data accumulation
  - Essential collaborators from each lab (names confirmed after the meeting).
    - FNAL/ANL: Camille Ginsburg (approved by Bob Kephart)
    - DESY: Sebastian Adehold (approved by Eckhard Elsen)
    - Jlab: Rongli Geng (approved by himself, and by Andrew Hutton)
    - Cornell: Zac Conway (to be confirmed, approved)
    - KEK: Yasuchika (Kirk) Yamamoto (approved by Kaoru Yokoya)
    - Others: TBD
- In the end, we may briefly discuss
  - how we may consider re-base line for the field gradient?



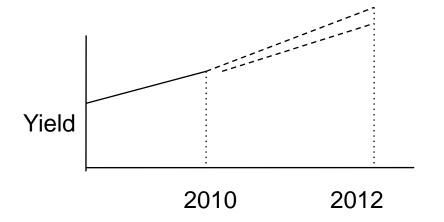
#### Some milestone

	2009							2010							
	05	06	07	80	09	10	11	12	1	2	3	4	5	6	7
Gradient and yield to be discussed															
Redefine yield															
Re-visit Yield															
Meeting Pla	an														
ADI-Desy															
TTC															
SRF-09															
ALCPG															
AAP															
GDE															
HEP Conf															



#### How we may settle Re-baseline

- Re-establish yield definition
- Provide progress of the yield, periodicallyk
- Figure out possible improvement, in future
- Set Rebaseline value:
  - Field Gradient and Yield





### Re-baselining the Field Gradient:

A Possible Scenario

#### In early 2010 (possibly in January) we will review the status:

- Understand the field gradient / process yield
- Scope the 2012 gradient/yield milestones achievable
  - based on understanding and extrapolation of available results,
  - Need consensus to cut in the data might be required due to, for instance, vendors, process modifications, experience, one-off errors....
- The 2012 target should be not just yield but on a larger scale economic minimum
- The statistics may not be as large as we originally desired...
  - our interpretation of the results may have to wait or we may be forced to be more conservative
- The TDP-2 period may allow for further refinement of component technologies



## Summary and Outcome Cavity Gradient

ADI Meeting May 29, 2009



#### Cavity Gradient: Discussed

- The cavity preparation recipe has been changed not to repeat too many cycles,
- Insufficient guide line for the gradient evaluation with the yield, and the yield value can be easily scattered, (35 MV/m at 15 50 % yield), depending on the 'cut', 'plot binning', or 'filtering' the measured results,
- How to treat cavity with many treatment and measurement? (the last performance? or the best performance?)
- What is the definition of 'Production yield' and 'Process yield'?
- Cavity gradient and yield criteria needs to be better defined and evaluated, as a starting point for re-baseline,
- It may be important to evaluate the yield based on how much costed/paid, in view of cost effective production and process,
- Production yield based on the number of cavities received from the vender (and paid for) would be important,
- A proposal (by Rongli): plot the yield for the first cycle and second cycle as a main evaluation tool



#### Cavity Gradient Action Items

- Gradient/yield evaluation:
  - Form task force to provide the yield and the progress, regularly,
  - Camille (Ginsburg) at Fermilab has been assigned to be the principal person in charge, and each lab need to assign the person in charge to cooperate with her,
  - The cavity gradient and yield progress may be informed at a occasion of SCRF webex meetings, and to be further reported at major GDE meetings.

#### Re-baseline:

- Scope the possible improvement by the end of TDP-2, and fix the rebaseline,
- Need to re-visit and to re-optimize two number of the gradient to reach in the vertical test (currently 35 MV/m) and the operational gradient at ILC (currently 31.5 MV/m),
- Re-visit RDR cost estimate of 80 % success rate (100/125) and fix the rebaseline of yield to be consistent.
- A possible solution could be 35 MV/m between 80 90 % yield,
- Need to consider the yield of cryomodule assembly (could not be 100 %).



### Backup



### **Guideline: Standard Procedure and Feedback Loop**

		Standard	(Optional	Acceptance Test/Inspection
		Fabrication/Process	action)	
Fabrication		Nb-sheet purchasing		Chemical component analysis
		Component (Shape) Fabrication		Optical inspect., Eddy current
		Cavity assembly with EBW	(tumbling	Optical inspection
Process		EP-1 (Bulk: ~150um)		
		Ultrasonic degreasing (detergent) or ethanol rinse		
	*	High-pressure pure-water rinsing		Optical inspection
		Hydrogen degassing at 600 C (?)	750 C	
		Field flatness tuning		
		EP-2 (~20um)		
		Ultrasonic degreasing or ethanol	(Flash/Fresh EP) (~5um))	
		High-pressure pure-water rinsing		
		General assembly		
		Baking at 120 C		
Cold Test (vertical tes		Performance Test with temperature and mode measurement	Temp. mapping	If cavity not meet specification Optical inspection



#### **R&D Mile Stone**

#### From TDP R&D Plan, Release 3, p8

#### 3.1.2 SCRF Technical design and R&D Milestones

The milestones for the TD Phase 1 and 2 SCRF goals outlined in section 3.1.1 (notably the S0, S1 and S2 programs) are given in Table 3.1.

Table 3.1: Milestones for the SCRF R&D Program.

High-gradient cavity performance at 35 MV/m according to the specified chemical process with a process yield of 50% in TDP1, and with a production yield of 90% in TDP2 (S0, see section 3.1.3 for definition of process yield)	2010 2012
Plug-compatible Cryomodule internal and external interface specifications to be defined:  - including considerations of tuneability and maintainability  - thermal balance and cryogenics operation  - beam dynamics (addressing issues such as orientation and alignment)	2009
Cavity-string performance in one cryomodule with the average gradient 31.5 MV based on a global effort (S1 and S1-global)	2010
Cryomodule-string performance achieving the average gradient 31.5 MV/m with full-beam loading and handling (S2)	2012



### Definition of Yields to be updated

- We may need to
  - update the Definition of "Process" and "Production"
     Yield given in R&D Plan (release 3, page 9)

For the purpose of evaluating progress towards producing cavities with a reproducible gradient near our goal, we have separated the concept of yield into two distinct definitions for the TD phases:

- For TD Phase 1, we define 'process yield' as the number of accepted cavities divided by the number of chemically processed cavities which fulfil some specified and justifiable criteria, such as those ordered from a qualified vendor or those passing specified mechanical test criteria. This allows us to separate fabrication-related defects, such as the pits or bumps in the vicinity of the electron-beam weld, from chemical surface treatment and cleaning-related problems. Final chemical treatment and rinsing is often done at an institution, rather than in industry, and is tightly coupled to the final assembly and testing procedure.
- For TD Phase 2, definition of 'production yield' is the number of accepted cavities divided by the number ordered. Production yield, as defined in the Reference Design, makes allowance for 20% of the cavities to be re-processed.



#### **Global Yield of Cavities Recently Tested**

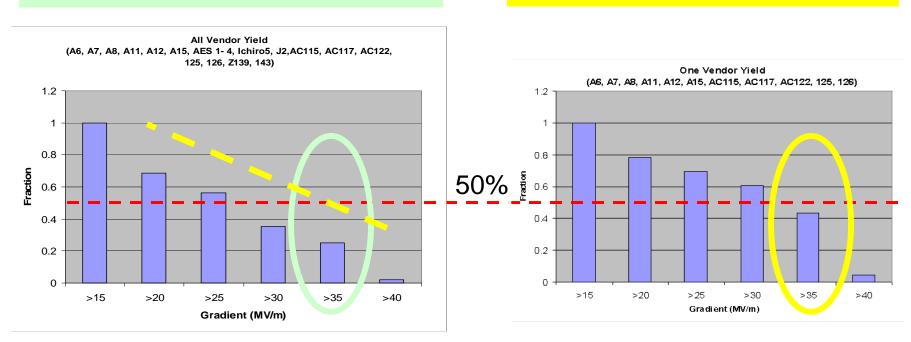
at Jlab and DESY

48 Tests, 19 cavities

ACCEL, AES, Zanon, Ichiro, Jlab

23 tests, 11 cavities

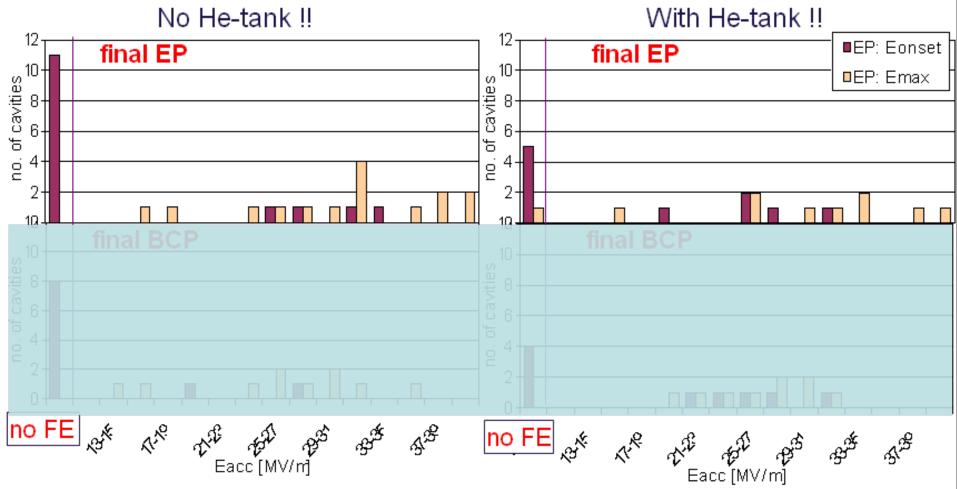
One Vendor



Yield 45 % at 35 MV/m being achieved by cavities with a qualified vendor!!

## Final preparation: Analysis of final test





- => as expected: some improvement with respect to field emission
- => "final EP" gives higher Emax than "final BCP"

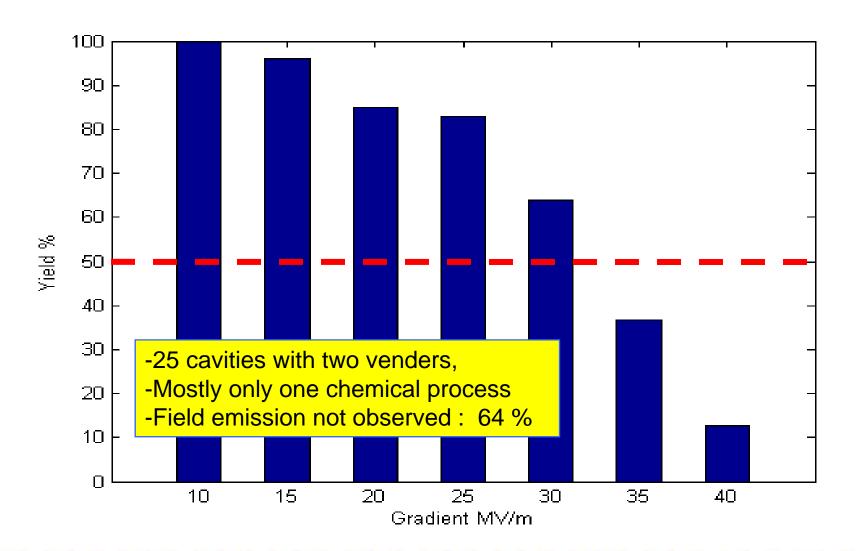






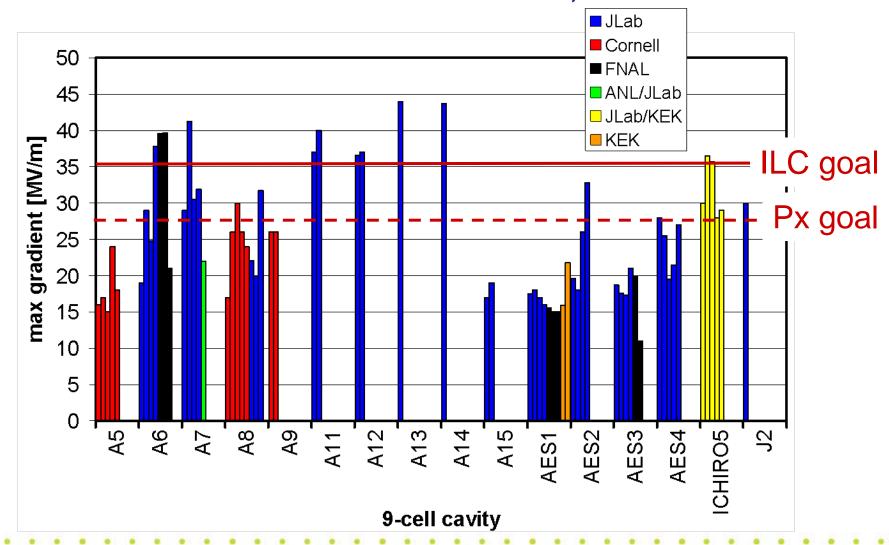
### **Recent Progress in Yield at DESY**

Data provided by D. Reschke, and reassembled by M. Ross





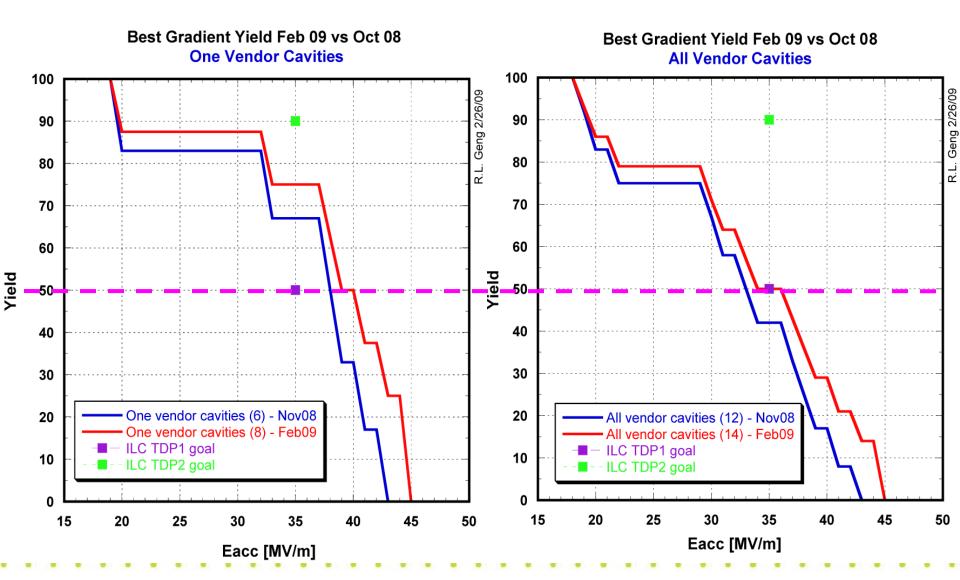
## Summary of 9-cell Vertical Tests in U.S. as of Feb., 2009



A90151218 eting at DESY

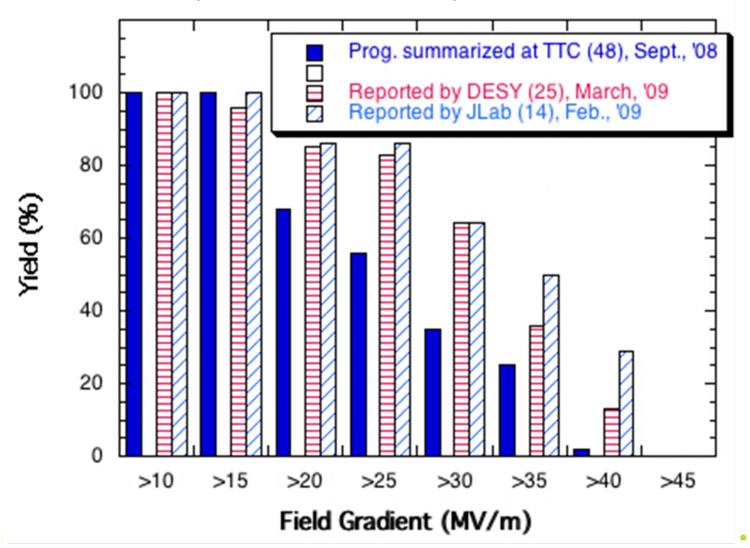


### Recent Gradient Yield Progress at JLab





## Progress summarized at TTC and recently reported by DESY/Jlab ('09)



# Rumbers of R&D Cavities for ILC partly from the TDP R&D Plan (release 3)

Order	Bef TDP	2008	2009	2010	Sum 2010	~ 2012
Ams (FY)	34	20	40	15	109	TBD
AS (FY)	15	3	13+1*	17+2	48+3	TBD
EU (CY)	68		26 (+808)**		94 (+808)	TBD
Sum	117	23	48 (+808)	34	222 (+808)	

- •Japan + China
- •\*\* 26 specific for ILC-R&D, 808 for XFEL mass production
- Order in 2010 and later is to be subject to budget available

Tests		2009		2010	2011	2012
Ams (FY)		45		70	TBD	TBD
AS (FY)		12		14	TBD	TBD
EU (CY) 090528		15		10	20	TBD
90528 Sum	A	DI Meetin	g at D	<b>ESY</b> 94	TBD	TBD <sup>28</sup>